



30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8 (Type K)

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C	
30V	$1.6 \text{m}\Omega$ @ $V_{GS} = 10V$	240A	

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{\text{DS(ON)}}$, yet maintain superior switching performance. This device is ideal for use in power management and load switch

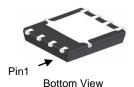
Applications

- DC-DC Converters
- Load Switch

PowerDI5060-8 (Type K)





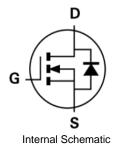


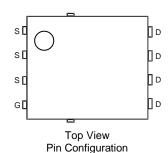
Features

- Thermally Efficient Package Cooler Running Applications
- <1.1mm Package Profile Ideal for Thin Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI[®]5060-8 (Type K)
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)





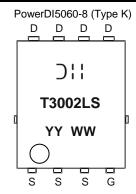
Ordering Information (Note 4)

7			
	Part Number	Case	Packaging
	DMT3002LPS-13	PowerDI5060-8 (Type K)	2,500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



☐ Hanufacturer's Marking

T3002LS = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 17 = 2017)

WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated. DMT3002LPS



Maximum Ratings (@ $T_C = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	±16	V		
Continuous Drain Current, V _{GS} = 10V (Note 7)	I _D	240 240	Α		
Maximum Continuous Body Diode Forward Current (Not	Is	100	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	400	Α		
Pulsed Continuous Body Diode Forward Current (10µs P	I _{SM}	400	Α		
Avalanche Current, L=3mH (Note 8)			I _{AS}	15	Α
Avalanche Energy, L=3mH (Note 8)			E _{AS}	700	mJ

Thermal Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	P_{D}	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	103	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	51	°C/W
Total Power Dissipation (Note 7)	T _C = +25°C	P _D	136	W
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	1.1	°C/W
Operating and Storage Temperature Range		T_J,T_STG	-55 to +150	°C

Electrical Characteristics (@ $T_C = +25$ °C, unless otherwise specified.)

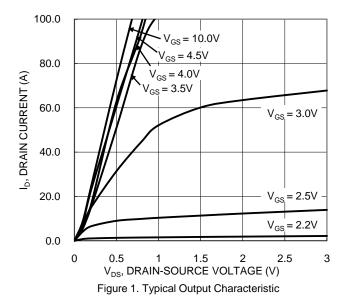
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV_{DSS}	30	_	_	V	$V_{GS} = 0V$, $I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 24V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	1	_	2	V	$V_{DS} = V_{GS}$, $I_D = 1mA$	
Static Drain-Source On-Resistance	D	_	1.25	1.6	mΩ	$V_{GS} = 10V, I_D = 25A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	2	2.5	mt2	$V_{GS} = 4.5V, I_D = 25A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.1	V	$V_{GS} = 0V, I_{S} = 25A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{ISS}	_	5,000	_		V _{DS} = 15V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	2,660	_	pF		
Reverse Transfer Capacitance	C _{RSS}	_	300				
Gate Resistance	R_{G}	_	0.75	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_G	_	37	_			
Total Gate Charge (V _{GS} = 10V)	Q_G	_	77	_	nC	V _{DS} = 15V. I _D = 25A	
Gate-Source Charge	Q_{GS}	_	10	_	IIC	V _{DS} = 15V, I _D = 25A	
Gate-Drain Charge	Q_{GD}	_	14	_			
Turn-On Delay Time	t _{D(ON)}	_	21	_		$V_{DD} = 15V, V_{GS} = 4.5V,$ $I_{D} = 25A, R_{G} = 4.7\Omega$	
Turn-On Rise Time	t _R	_	45	_			
Turn-Off Delay Time	t _{D(OFF)}	_	32	_	ns		
Turn-Off Fall Time	t _F	_	26	_			
Body Diode Reverse Recovery Time	t _{RR}	_	44	_	ns	1- 15A di/dt 100A/vo	
Body Diode Reverse Recovery Charge	Q_{RR}	_	52	_	nC	I _S = 15A, di/dt = 100A/μs	

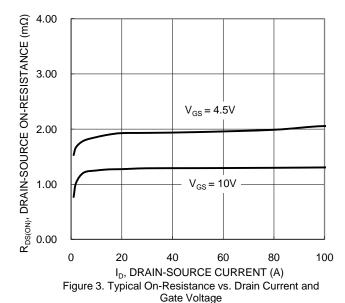
Notes:

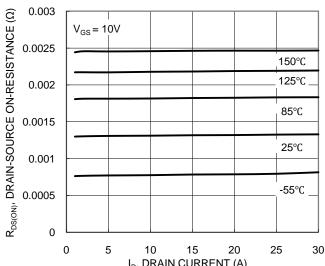
- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 9. Short duration pulse test used to minimize self-heating effect.
 10. Guaranteed by design. Not subject to product testing.



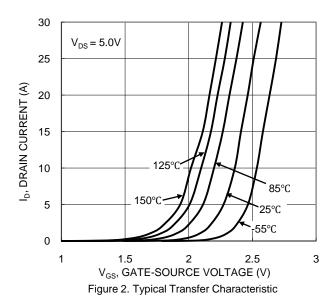


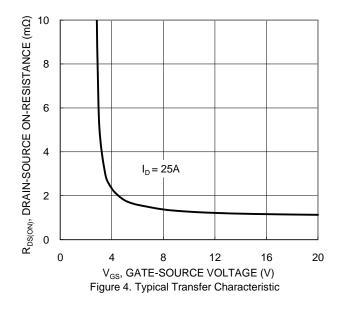






I_D, DRAIN CURRENT (A)
Figure 5. Typical On-Resistance vs. Drain Current and
Temperature





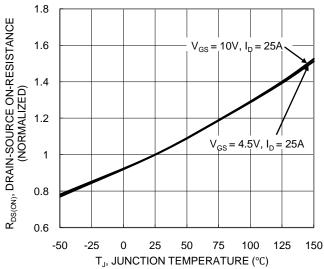


Figure 6. On-Resistance Variation with Temperature





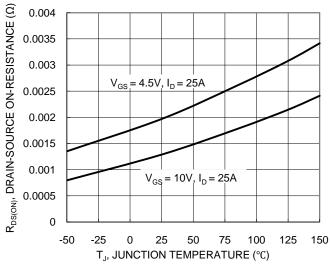


Figure 7. On-Resistance Variation with Temperature

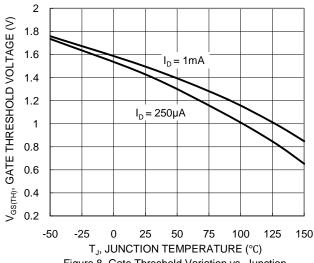


Figure 8. Gate Threshold Variation vs. Junction Temperature

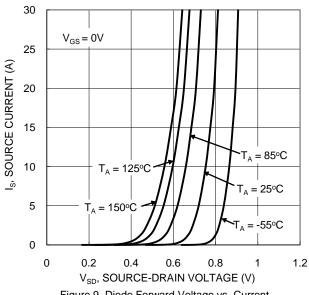
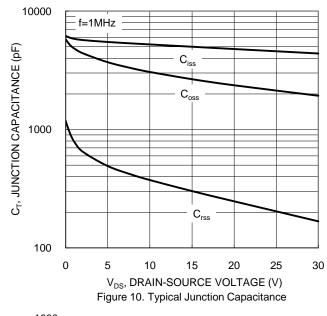


Figure 9. Diode Forward Voltage vs. Current



10 8 6 4 $V_{DS} = 15V, I_{D} = 25A$ 2 0 0 20 40 60 80 $Q_g(nC)$ Figure 11. Gate Charge

1000 R_{DS(ON)} LIMITED 100 ID, DRAIN CURRENT (A) 10 1 $T_{J(MAX)}$ =150°C T_{C} =25°C P_w=100ms Single Pulse DUT on infinite heatsink V_{GS}=10V 0.01 10 100 0.1 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

 $V_{GS}(V)$

April 2017

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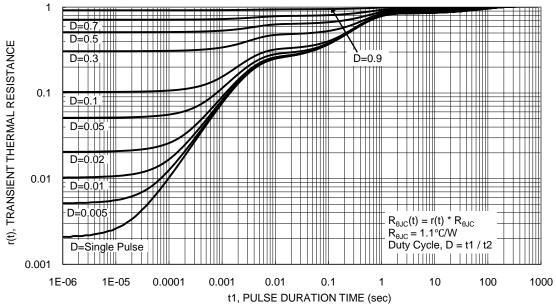


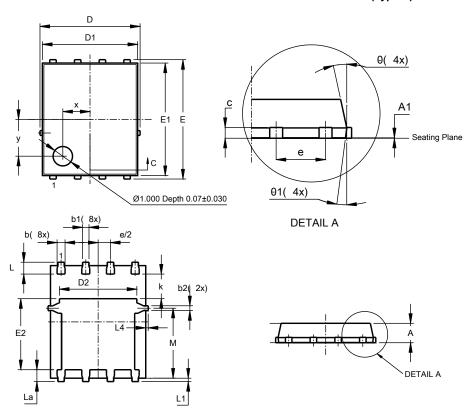
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)

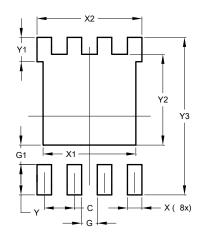


PowerDI5060-8 (Type K)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05	0.02		
b	0.33	0.51	0.41		
b1	0.300	0.366	0.333		
b2	0.20	0.35	0.25		
С	0.23	0.33	0.277		
D	5	.15 BS0	3		
D1	4.85	4.95	4.90		
D2	-	-	3.98		
Е	6	.15 BS0			
E1	5.75	5.85	5.80		
E2	3.56	3.725	3.66		
Е	1	.27BSC	;		
k	-	-	1.27		
L	0.51	0.71	0.61		
La	0.51	0.675	0.61		
L1	0.05	0.20	0.175		
L4	-	-	0.125		
М	3.50	3.71	3.605		
X	-	-	1.400		
у	-	-	1.900		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value		
Dilliensions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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